



Automotive and Discrete Group

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ADG addresses four end markets









Q3 Automotive market pick up





Source: LMCA 2020 LV Projection Oct. 13th 2020: ACEA European Automobile Manufacturers Association, Fuel type Q2 2020

ST outperforming the market





Market evolution since the last CMD

What has stayed the same

Smart Mobility trends

- Strong electrification trend in automotive and industrial markets
- Car connectivity, active safety and domain control drive the digitalization of the vehicles

Increasing semiconductor content

- Semiconductor pervasiveness in automotive
- Power semiconductors are a key enabler for automotive and industrial

Car sales under pressure

Macro economic trends and consumer behavior

What has changed after last CMD

Deteriorated environment

- Pandemic and macro-economy trend deterioration pushed down 2020 car sales by 20% and strongly impacted factory automation
- Trade tensions increasing pressure in the supply chain

Car makers adapting

- Full autonomous driving projects postponed
- Tailwinds in ADAS L2 and L2++ increasing adoption
- Vehicle electrification is now mainstream at all car makers around the globe



ADG perspective and strategy evolution

What has stayed the same

- Company commitment to automotive and industrial
- Investments in technology innovation
- Commitment on power technologies in both traditional silicon and new materials
- Ambitions to lead in car electrification and digitalization
- Success in SiC with fast new program acquisition run-rate
- All key R&D programs on track, in spite of the pandemic

What has changed after last CMD

- Car sales softening leading to higher pressure on legacy automotive weakening group top-line
- Acceleration of the ongoing actions plan to better serve automotive macro-trends
- Expanded electrification programs based on SiC, IGBT, Microcontrollers, and Smart power solutions
- Accelerated partnerships in Asia for electrification including emerging players who are now leading
- Better ADAS volumes with pervasion of L2/L2++ more than compensating volume reduction
- Increased effort on GaN with acquisition to improve time-to-volume - complementing internal programs



Automotive market recovering





Electric and assisted vehicle volume are growing despite light-vehicle market headwind





Source: IHS - Car production by propulsion system and Region - Sep.23.2020. ST internal

Source: IHS - Vehicle Production by Autonomy Level May 2020 forecast; ST internal

Automotive megatrends driving silicon pervasion





ADG automotive business evolution





Key actions taken by ADG to accelerate the focus on new Automotive trends

Boost innovation in traditional automotive Smart Power

Transform current portfolio focusing on:

- LED/OLED Drivers
- EV Battery management system
- EV Gate driver
- Transmission & Steering
- ADAS power management
- Power Distribution 12-48V

Expand portfolio leveraging ST cutting-edge technologies

- Product proliferation on SiC
- Time to volume acceleration on GaN
- Dedicated MCU for RF-based ADAS
- Stellar roadmap expansion
- IGBT Trench for mid-level inverters
- 48V hybrid solutions

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• Full system solution for smart charging

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Focus on new macro trends, differentiating customer base

- Redeploy smart power ASIC resources to SiC, GaN and Low Voltage for EVs and battery tools
- Leverage BCD competence and resources to speed up **GaN development & deployment**
- Boost Asia support with dedicated R&D team
- Dedicated development support team for new applications leveraging competence centers

Move product R&D expenses progressively to new automotive trends





Innovation in the traditional domain: Smart Power (BCD)

ADAS and autonomous driving power management

Smart Power leadership In car electrification

Battery **Traction inverter** Power **Radar-based Camera-based Autonomous** & on-board management distribution systems system driving L3/4 charger system L9963 Family L9678 & L9679 L950x Family L5965S and **STPM80x family STPM020** Scalable solutions from Battery cut-off & fire-off **STPM066S** family Integrated & distributed High current power SiC & IGBT Isolated 48V up to 800V disconnecting power line power management management for pre-driver up to 6kV for Power management for Best in class cells solution for L2+ ADAS in case of emergency or powerful processors traction inverter, DC-DC radar system voltage accuracy crashes ASIL-D & OBC systems In production **Full production 2020** In development In gualification **Production H1'22** In production



Digitalization and shared mobility boost silicon content

ADAS L2 & L2++ acceleration trend supporting pervasion	ADAS L4/L5 to support Robo-Taxi & Shared Autonomous Mobility increasing silicon value per car	SW reconfigurable vehicle: new car architecture	Cloud connectivity for Big-Data harvesting
NCAP Regulation (L2) boosting Si content for assisted driving system, increasing safety > 40%	High-value electronics for Autonomous Vehicles enable mobility-as-Service	Remote, seamless SW update needs new Vehicle Architecture	Global Big Data from vehicles opens Service Company opportunities
L2 & L2++ Share on Car Production 20% Increased Si/\$ x Car 2020 2025	Average silicon content per car 5 K\$ L4/5	x10 Computational Power x Car +30 Digital Silicon Value	Vision & Telematics processors



ST car digitalization portfolio matches market trends

ADAS L2 & L2++ acceleration trend supporting pervasion	ADAS L4/L5 to support Robo-Taxi & Shared Autonomous Mobility increasing silicon value per car	SW reconfigurable vehicle: new car architecture	Cloud connectivity for Big-Data harvesting
EyeQ4, EyeQ5L, EyeQ6L for L2++ Radar MMIC V2x Kit with Autotalks 32-bit MCU for Radar	EyeQ for Autonomous Driving Image: Comparison of the second secon	32-bit 28 nm FD-SOI MCUs enabling Software isolation & Over-the-air SW updates	Telemaco3P cloud connectivity & telematics
>54Munits of Intel Mobileye EYQx delivered on the market	32-bit MCU automotive Tailored for ADAS		



Architecture migration increases MCU and smart power silicon content per vehicle

Domain architecture increasing MCU TAM by > 1B\$



Domain Architecture					
Central Gateway MPU/MCU					
Domain 2 MCU	Domain 3 MCU	Domain 4 <mark>MPU</mark>			
		-			
		-			
	Central (MPU) Domain 2 MCU	Central Gateway MPU/MCU Domain 2 MCU Domain 3 MCU			

- Need for MCU with high computational power and specialized embedded memory for real-time operation & over-the-air SW update
- Increased ASP to thanks to extended functionality
- 30% MCU TAM increase thanks to new architecture

In-vehicle power distribution creates additional TAM >1B\$



- Protected switches require optimized power stage to manage mid/high current load
- High logic computation requirement to manage overload and hazard conditions during abnormal operation



ST offer for architecture migration to domain/zone controller

Stellar 32-bit ARM Multicore Real-Time MCU Verified and Selected by Bosch for next Gen Systems	ST Smart power for new architecture power distribution	
Simplify the execution of multiple software programs in hardware isolated "virtual" CPUs with peripherals firewalls	New VIPower technology (M0-A11) the best choice for in- vehicle power grid	
 Phase change memory enables cost effective OTA software updates with no interruption of software execution <i>but</i> without doubling the memory size 	 Partnership with key market players to capture an important share of the 1B\$ additional TAM 	
28 nm FD-SOI TechnologyPhase Change Memory	Fuse 180 nm VIPower Technology	
Reference partner BOSCH	Leading Partner Leading European Car maker	



ADG system offer for electrified mobility – beyond SiC

Galvanic Isolated Drivers

• Galvanic isolated families of functional safety pre-drivers up to 6 kV isolation

Rectifier, Fast Diodes & AC Switches: TRIAC & SCR

• Extensive offer for multiple customer needs for On-board charger and Charging Pile

32-bit MCU for electrification

 Dedicated for power conversion system entry-level electrification to Battery EV



Power Module

Standard & Custom solutions for

- Molded / Ceramic Modules
- Air flow / Liquid cooling

Partnership for SiC MOSFET/ IGBT for Semikron power modules for electric vehicle traction inverter & high-end industrial



Low Voltage MOSFET

- Family covering 30 V ~ 150 V applications
- Specific target to 48 V hybrid mobility

IGBT & HV MOSFET

- Complementing SiC offer
- Broad range IGBT solution (600 V 1700 V)



Power semiconductors are vital for automotive and industrial applications



Increasing power semiconductor contents in automotive applications Power semiconductor pervasiveness in key industrial applications









Silicon & Wide-Bandgap material



Continue to strengthen our SiC market leadership

Leading global supplier for Silicon Carbide >50% market share

for SiC MOSFETs in automotive and industrial markets

Partnering with leading global players with solutions already in production

<u>Award rate acceleration</u> More than **68 projects** in development: ~50% Industrial & ~50% in Automotive











Silicon Carbide leadership differentiators

ST key differentiators in SiC

- Two manufacturing sites
- Silicon architecture with the best-in-the-market channel resistivity thanks to an optimized planar structure and dedicated EPI
- Strong synergy between R&D and Manufacturing
- Evolution planned with a trench structure but with a Super Junction approach

Manufacturing performance in line with silicon standard

Silicon Industry Standard Yield Rate

Silicon Carbide Yield Progression

20+ Years of R&D commitment



SiC manufacturing strategy for vertical integration

Substrate supply chain strategy: **Norstel 100%** acquisition pursuing vertical integration to support the **1B\$** SiC revenue target **by 2025**



- >40% production with internal substrate by 2024
- R&D investments to move to 200mm production



Internal **Substrate** production volume with an **additional manufacturing plant** with **200mm** compatible equipment for supply security and cost optimization



Accelerating our Gallium Nitride execution strategy

Partnerships and acquisitions to accelerate our GaN roadmap

TSMC partnership

A step forward in product development and epitaxy expertise for our long-term GaN roadmap, ecosystem and business

EXAGAN majority stake acquisition

Leveraging ST's market expertise and TSMC foundry knowhow to bring Power GaN & GaN ICs to market

100 V

ST to offer a full range of **GaN-based** power device solutions for all markets, including a wide range of normally-off products from **100 to 650 V** housed in state-of-the-art packages

Automotive and Industrial customers sampling in 2019

- 1st 650 V product Production ramp-up by end of 2020
- 1st 100 V product Production planned H2 2021



ST**POWE**

650 V

ST GaN: comprehensive strategy to support innovation, time-to-market and high volume

STPOWER

Full application coverage

On-board Charger

DC-DC Converter

Premium Audio

LIDAR

Optimized manufacturing strategy

External

Complement roadmap by partnering with **TSMC** to improve time-to-market and enable multi-site high volume





Solar Inverter

Server Power Supply

Portable Adapter

Data center

IGBT: Leadership in fast growing industrial and automotive domains

ST Ambition

To become a leader in IGBT for automotive and industrial



Innovation drives our market share gains thanks to tailored application focus



- Product offer based on 10 technology options with ~600 products
- Plan to enrich the offer with an additional 6 Series by 2023



Growth rate comparison based on ST projection (award pipeline) and OMDIA/IHS, power-discrete-module-market-tracker-interim-2019

Continue growth in Industrial focusing on newer high-silicon content applications





Source: IHS Industrial semiconductor Market Tracker Q3 2019, Tool Market estimated by Market data and ST Internal

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ADG takeaways

- ADG is growing faster than the market in all application domains it addresses
- ST has anticipated the automotive market transformation and is focused on growing business in smart mobility applications, driven by electrification and digitalization
- Action has been taken to progressively move skills and R&D resources to enlarge our product portfolio and market coverage
 - Benefitting of strong internal know-how
 - Optimizing R&D cost vs market dynamics





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